

MC44608

Few External Components Reliable and Flexible SMPS Controller

The MC44608 is a high performance voltage mode controller designed for off-line converters. This high voltage circuit that integrates the start-up current source and the oscillator capacitor, requires few external components while offering a high flexibility and reliability.

The device also features a very high efficiency stand-by management consisting of an effective Pulsed Mode operation. This technique enables the reduction of the stand-by power consumption to approximately 1.0 W while delivering 300 mW in a 150 W SMPS.

- Integrated Start-Up Current Source
- Lossless Off-Line Start-Up
- Direct Off-Line Operation
- Fast Start-Up

General Features

- Flexibility
- Duty Cycle Control
- Undervoltage Lockout with Hysteresis
- On Chip Oscillator Switching Frequency 40, 75, or 100 kHz
- Secondary Control with Few External Components

Protections

- Maximum Duty Cycle Limitation
- Cycle by Cycle Current Limitation
- Demagnetization (Zero Current Detection) Protection
- “Over V_{CC} Protection” Against Open Loop
- Programmable Low Inertia Over Voltage Protection Against Open Loop
- Internal Thermal Protection

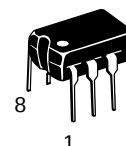
SMPS Controller

- Pulsed Mode Techniques for a Very High Efficiency Low Power Mode
- Lossless Startup
- Low dV/dT for Low EMI Radiations



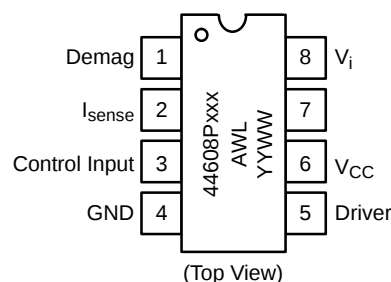
ON Semiconductor™

<http://onsemi.com>



PDIP-8
P SUFFIX
CASE 626

PIN CONNECTIONS AND MARKING DIAGRAM



AWL = Manufacturing Code
YYWW = Date Code

ORDERING INFORMATION

Device	Switching Frequency	Package	Shipping
MC44608P40	40 kHz	Plastic DIP-8	50/Rail
MC44608P75	75 kHz	Plastic DIP-8	50/Rail
MC44608P100	100 kHz	Plastic DIP-8	50/Rail

MC44608

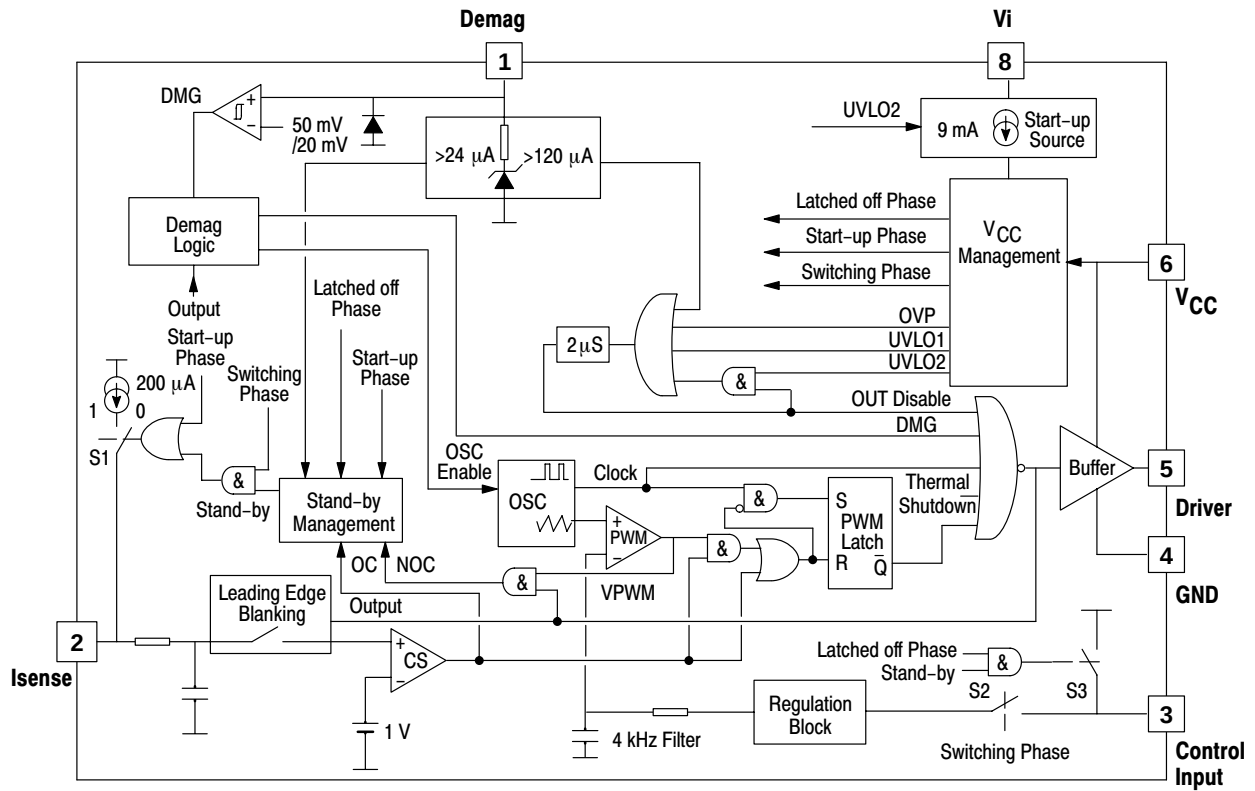


Figure 1. Representative Block Diagram

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Total Power Supply Current	I_{CC}	30	mA
Output Supply Voltage with Respect to Ground	V_{CC}	16	V
All Inputs except V_i	V_{inputs}	-1.0 to +16	V
Line Voltage Absolute Rating	V_i	500	V
Recommended Line Voltage Operating Condition	V_i	400	V
Power Dissipation and Thermal Characteristics			
Maximum Power Dissipation at $T_A = 85^\circ\text{C}$	P_D	600	mW
Thermal Resistance, Junction-to-Air	$R_{\theta JA}$	100	$^\circ\text{C/W}$
Operating Junction Temperature	T_J	150	$^\circ\text{C}$
Operating Ambient Temperature	T_A	-25 to +85	$^\circ\text{C}$

MC44608

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
----------------	--------	-----	-----	-----	------

OUTPUT SECTION

Output Resistor Sink Resistance Source Resistance	R_{OL} R_{OH}	5.0 –	8.5 15	15 –	Ω
Output Voltage Rise Time (from 3.0 V up to 9.0 V) (Note 1.)	t_r	–	50	–	ns
Output Voltage Falling Edge Slew-Rate (from 9.0 V down to 3.0 V) (Note 1.)	t_f	–	50	–	ns

CONTROL INPUT SECTION

Duty Cycle @ $I_{pin3} = 2.5$ mA	d_{2mA}	–	–	2.0	%
Duty Cycle @ $I_{pin3} = 1.0$ mA	d_{1mA}	36	43	48	%
Control Input Clamp Voltage (Switching Phase) @ $I_{pin3} = -1.0$ mA		4.75	5.0	5.25	V
Latched Phase Control Input Voltage (Stand-by) @ $I_{pin3} = +500$ μ A	$V_{LP-stby}$	3.4	3.9	4.3	V
Latched Phase Control Input Voltage (Stand-by) @ $I_{pin3} = +1.0$ mA	$V_{LP-stby}$	2.4	3.0	3.7	V

CURRENT SENSE SECTION

Maximum Current Sense Input Threshold	V_{CS-th}	0.95	1.0	1.05	V
Input Bias Current	I_{B-CS}	-1.8	–	1.8	μ A
Stand-By Current Sense Input Current	$I_{CS-stby}$	180	200	220	μ A
Start-up Phase Current Sense Input Current	$I_{CS-stup}$	180	200	220	μ A
Propagation Delay (Current Sense Input to Output @ V_{TH} T MOS = 3.0 V)	$T_{PLH(In/Out)}$	–	220	–	ns
Leading Edge Blanking Duration MC44608P40	T_{LEB}	–	480	–	ns
Leading Edge Blanking Duration MC44608P75	T_{LEB}	–	250	–	ns
Leading Edge Blanking Duration MC44608P100	T_{LEB}	–	200	–	ns
Leading Edge Blanking + Propagation Delay MC44608P40	T_{DLY}	500	680	900	ns
Leading Edge Blanking + Propagation Delay MC44608P75	T_{DLY}	370	470	570	ns
Leading Edge Blanking + Propagation Delay MC44608P100	T_{DLY}	300	420	500	ns

OSCILLATOR SECTION

Normal Operation Frequency MC44608P40	f_{osc}	36	40	44	kHz
Normal Operation Frequency MC44608P75	f_{osc}	68	75	82	kHz
Normal Operation Frequency MC44608P100	f_{osc}	90	100	110	kHz
Maximum Duty Cycle @ $f = f_{osc}$	d_{max}	78	82	86	%

OVERVOLTAGE SECTION

Quick OVP Input Filtering ($R_{demag} = 100$ k Ω)	T_{filt}	–	250	–	ns
Propagation Delay ($I_{demag} > I_{ovp}$ to output low)	$T_{PHL(In/Out)}$	–	2.0	–	μ s
Quick OVP Current Threshold	I_{OVP}	105	120	140	μ A
Protection Threshold Level on V_{CC}	V_{CC-OVP}	14.8	15.3	15.8	V
Minimum Gap Between V_{CC-OVP} and $V_{stup-th}$	$V_{CC-OVP} - V_{stup}$	1.0	–	–	V

1. This parameter is measured using 1.0 nF connected between the output and the ground.

MC44608

ELECTRICAL CHARACTERISTICS ($V_{CC} = 12\text{ V}$, for typical values $T_A = 25^\circ\text{C}$, for min/max values $T_A = -25^\circ\text{C}$ to $+85^\circ\text{C}$ unless otherwise noted) (Note 2.)

Characteristic	Symbol	Min	Typ	Max	Unit
DEMAGNETIZATION DETECTION SECTION (Note 3.)					
Demag Comparator Threshold (V_{pin1} increasing)	V_{dmg-th}	30	50	69	mV
Demag Comparator Hysteresis (Note 4.)	H_{dmg}	—	30	—	mV
Propagation Delay (Input to Output, Low to High)	$t_{PHL}(In/Out)$	—	300	—	ns
Input Bias Current ($V_{demag} = 50\text{ mV}$)	I_{dem-lb}	−0.6	—	—	μA
Negative Clamp Level ($I_{demag} = -1.0\text{ mA}$)	$V_{cl-neg-dem}$	−0.9	−0.7	−0.4	V
Positive Clamp Level @ $I_{demag} = 125\text{ }\mu\text{A}$	$V_{cl-pos-dem-H}$	2.05	2.3	2.8	V
Positive Clamp Level @ $I_{demag} = 25\text{ }\mu\text{A}$	$V_{cl-pos-dem-L}$	1.4	1.7	1.9	V

OVERTEMPERATURE SECTION

Trip Level Over Temperature	T_{high}	—	160	—	$^\circ\text{C}$
Hysteresis	T_{hyst}	—	30	—	$^\circ\text{C}$

STAND-BY MAXIMUM CURRENT REDUCTION SECTION

Normal Mode Recovery Demag Pin Current Threshold	I_{dem-NM}	20	25	30	μA
--	--------------	----	----	----	---------------

K FACTORS SECTION FOR PULSED MODE OPERATION

I_{CCS} / I_{stup}	MC44608P40	10 x K1	2.4	2.9	3.8	—
I_{CCS} / I_{stup}	MC44608P75	10 x K1	2.8	3.3	4.2	—
I_{CCS} / I_{stup}	MC44608P100	10 x K1	3.1	7.0	4.5	—
I_{CCL} / I_{stup}		$10^3 \times K2$	46	52	63	—
$(V_{stup} - UVLO2) / (V_{stup} - UVLO1)$		$10^2 \times K_{sstup}$	1.8	2.2	2.6	—
$(UVLO1 - UVLO2) / (V_{stup} - UVLO1)$		$10^2 \times K_{sl}$	90	120	150	—
I_{CS} / V_{csth}		$10^6 \times Y_{cstby}$	175	198	225	—
Demag ratio $I_{ovp} / I_{dem\text{ NM}}$		Dm_{gr}	3.0	4.7	5.5	—
$(V3\ 1.0\text{ mA} - V3\ 0.5\text{ mA}) / (1.0\text{ mA} - 0.5\text{ mA})$		R3	—	1800	—	Ω
$V_{control\text{ Latch-off}}$		V3	—	4.8	—	V

SUPPLY SECTION

Minimum Start-up Voltage	V_{ilow}	—	—	50	V
V_{CC} Start-up Voltage	$V_{stup-th}$	12.5	13.1	13.8	V
Output Disabling V_{CC} Voltage After Turn On	V_{uvlo1}	9.5	10	10.5	V
Hysteresis ($V_{stup-th} - V_{uvlo1}$)	$H_{stup-uvlo1}$	—	3.1	—	V
V_{CC} Undervoltage Lockout Voltage	V_{uvlo2}	6.2	6.6	7.0	V
Hysteresis ($V_{uvlo1} - V_{uvlo2}$)	$H_{uvlo1-uvlo2}$	—	3.4	—	V
Absolute Normal Condition V_{CC} Start Current @ ($V_i = 100\text{ V}$) and ($V_{CC} = 9.0\text{ V}$)	$-(I_{CC})$	7.0	9.5	12.8	mA
Switching Phase Supply Current (no load) MC44608P40 MC44608P75 MC44608P100	I_{CCS}	2.0 2.4 2.6	2.6 3.2 3.4	3.6 4.0 4.5	mA
Latched Off Phase Supply Current	$I_{CC-latch}$	0.3	0.5	0.68	mA
Hiccup Mode Duty Cycle (no load)	δ_{Hiccup}	—	10	—	%

- Adjust V_{CC} above the start-up threshold before setting to 12 V. Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient as possible.
- This function can be inhibited by connecting pin 1 to GND.
- Guaranteed by design (non tested).

PIN FUNCTION DESCRIPTION

Pin	Name	Description
1	Demag	The Demag pin offers 3 different functions: Zero voltage crossing detection (50 mV), 24 μ A current detection and 120 μ A current detection. The 24 μ A level is used to detect the secondary reconfiguration status and the 120 μ A level to detect an Over Voltage status called Quick OVP.
2	I_{sense}	The Current Sense pin senses the voltage developed on the series resistor inserted in the source of the power MOSFET. When I_{sense} reaches 1.0 V, the Driver output (pin 5) is disabled. This is known as the Over Current Protection function. A 200 μ A current source is flowing out of the pin 3 during the start-up phase and during the switching phase in case of the Pulsed Mode of operation. A resistor can be inserted between the sense resistor and the pin 2, thus a programmable peak current detection can be performed during the SMPS stand-by mode.
3	Control Input	A feedback current from the secondary side of the SMPS via the opto-coupler is injected into this pin. A resistor can be connected between this pin and GND to allow the programming of the Burst duty cycle during the Stand-by mode.
4	Ground	This pin is the ground of the primary side of the SMPS.
5	Driver	The current and slew rate capability of this pin are suited to drive Power MOSFETs.
6	V_{CC}	This pin is the positive supply of the IC. The driver output gets disabled when the voltage becomes higher than 15 V and the operating range is between 6.6 V and 13 V. An intermediate voltage level of 10 V creates a disabling condition called Latched Off phase.
7		This pin is to provide isolation between the V_i pin 8 and the V_{CC} pin 6.
8	V_i	This pin can be directly connected to a 500 V voltage source for start-up function of the IC. During the Start-up phase a 9.0 mA current source is internally delivered to the V_{CC} pin 6 allowing a rapid charge of the V_{CC} capacitor. As soon as the IC starts-up, this current source is disabled.

OPERATING DESCRIPTION

Regulation

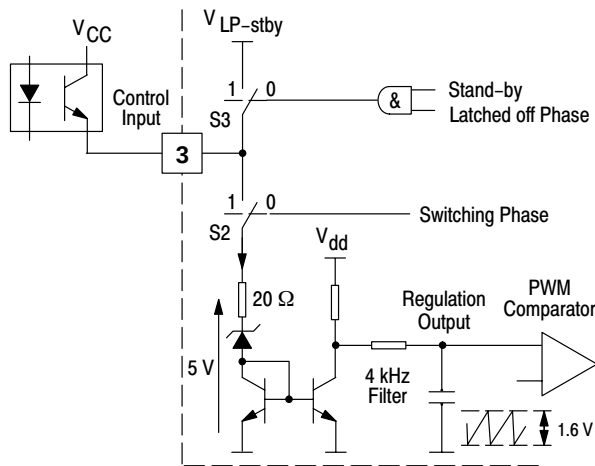


Figure 2. Regulator

The pin 3 senses the feedback current provided by the opto coupler. During the switching phase the switch S2 is closed and the shunt regulator is accessible by the pin 3. The shunt regulator voltage is typically 5.0 V. The dynamic resistance of the shunt regulator represented by the zener diode is 20 Ω . The gain of the Control input is given on Figure 11 which shows the duty cycle as a function of the current injected into the pin 3.

A 4.0 kHz filter network is inserted between the shunt regulator and the PWM comparator to cancel the high frequency residual noise.

The switch S3 is closed in Stand-by mode during the Latched Off Phase while the switch S2 remains open. (See section PULSED MODE DUTY CYCLE CONTROL).

The resistor $R_{dpulsed}$ (R_{duty} cycle burst) has no effect on the regulation process. This resistor is used to determine the burst duty cycle described in the chapter “Pulsed Duty Cycle Control” on page 8.

PWM Latch

The MC44608 works in voltage mode. The on-time is controlled by the PWM comparator that compares the oscillator sawtooth with the regulation block output (refer to the block diagram on page 2).

The PWM latch is initialized by the oscillator and is reset by the PWM comparator or by the current sense comparator in case of an over current. This configuration ensures that only a single pulse appears at the circuit output during an oscillator cycle.

Current Sense

The inductor current is converted to a positive voltage by inserting a ground reference sense resistor R_{sense} in series with the power switch.

The maximum current sense threshold is fixed at 1.0 V. The peak current is given by the following equation:

$$I_{pk\max} = \frac{1}{R_{sense}(\Omega)} (A)$$

In stand-by mode, this current can be lowered as due to the activation of a 200 μA current source:

$$I_{pk_max-stby} = \frac{1 - (R_{CS}(k\Omega) \times 0,2)}{R_{sense}(\Omega)} (A)$$

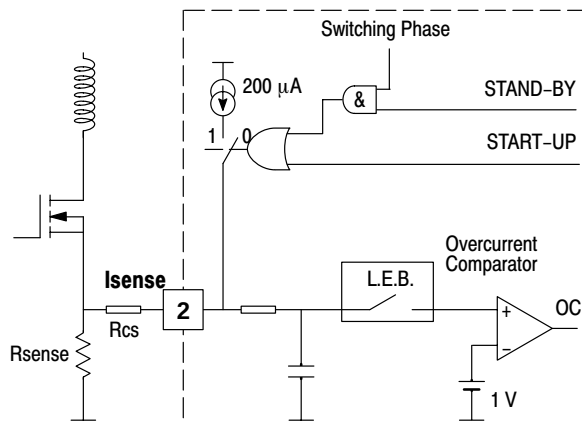


Figure 3. Current Sense

The current sense input consists of a filter (6.0 k Ω , 4.0 pF) and of a leading edge blanking. Thanks to that, this pin is not sensitive to the power switch turn on noise and spikes and practically in most applications, no filtering network is required to sense the current.

Finally, this pin is used:

- as a protection against over currents ($I_{sense} > I$)
- as a reduction of the peak current during a Pulsed Mode switching phase.

The overcurrent propagation delay is reduced by producing a sharp output turn off (high slew rate). This results in an abrupt output turn off in the event of an over current and in the majority of the pulsed mode switching sequence.

Demagnetization Section

The MC44608 demagnetization detection consists of a comparator designed to compare the V_{CC} winding voltage to a reference that is typically equal to 50 mV.

This reference is chosen low to increase effectiveness of the demagnetization detection even during start-up.

A latch is incorporated to turn the demagnetization block output into a low level as soon as a voltage less than 50 mV is detected, and to keep it in this state until a new pulse is generated on the output. This avoids any ringing on the input signal which may alter the demagnetization detection.

For a higher safety, the demagnetization block output is also directly connected to the output, which is disabled during the demagnetization phase.

The demagnetization pin is also used for the quick, programmable OVP. In fact, the demagnetization input current is sensed so that the circuit output is latched off when this current is detected as higher than 120 μA .

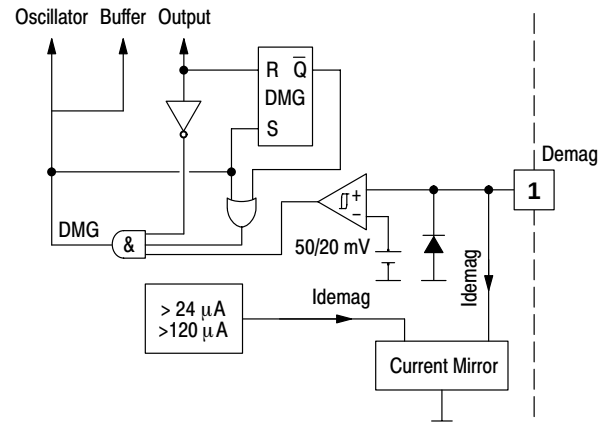


Figure 4. Demagnetization Block

This function can be inhibited by grounding it but in this case, the quick and programmable OVP is also disabled.

Oscillator

The MC44608 contains a fixed frequency oscillator. It is built around a fixed value capacitor C_T successively charged and discharged by two distinct current sources I_{CH} and I_{DCH} . The window comparator senses the C_T voltage value and activates the sources when the voltage is reaching the 2.4 V/4.0 V levels.

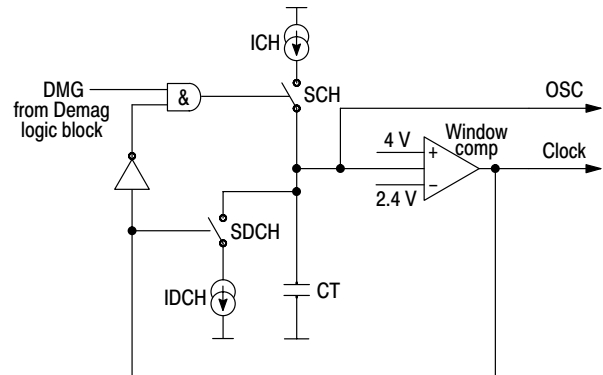


Figure 5. Oscillator Block

The complete demagnetization status DMG is used to inhibit the recharge of the C_T capacitor. Thus in case of incomplete transformer demagnetization the next switching cycle is postpone until the DMG signal appears. The oscillator remains at 2.4 V corresponding to the sawtooth valley voltage. In this way the SMPS is working in the so called SOPS mode (Self Oscillating Power Supply). In that case the effective switching frequency is variable and no longer depends on the oscillator timing but on the external working conditions (Refer to DMG signal in the Figure 6).

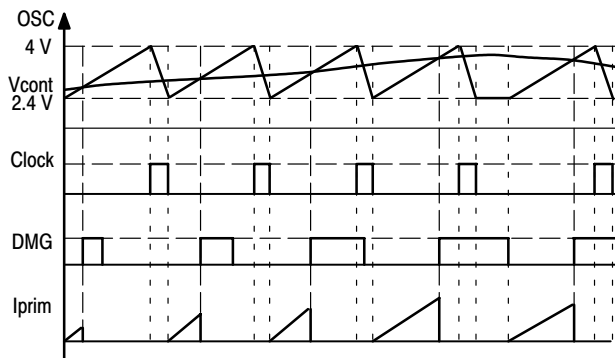


Figure 6.

The OSC and Clock signals are provided according to the Figure 6. The Clock signals correspond to the CT capacitor discharge. The bottom curve represents the current flowing in the sense resistor R_{cs} . It starts from zero and stops when the sawtooth value is equal to the control voltage V_{cont} . In this way the SMPS is regulated with a voltage mode control.

Overvoltage Protection

The MC44608 offers two OVP functions:

- a fixed function that detects when V_{CC} is higher than 15.4 V
- a programmable function that uses the demag pin. The current flowing into the demag pin is mirrored and compared to the reference current I_{ovp} (120 μA). Thus this OVP is quicker as it is not impacted by the V_{CC} inertia and is called QOVP.

In both cases, once an OVP condition is detected, the output is latched off until a new circuit START-UP.

Start-up Management

The V_i pin 8 is directly connected to the HV DC rail V_{in} . This high voltage current source is internally connected to the V_{CC} pin and thus is used to charge the V_{CC} capacitor. The V_{CC} capacitor charge period corresponds to the Start-up phase. When the V_{CC} voltage reaches 13 V, the high voltage 9.0 mA current source is disabled and the device starts working. The device enters into the switching phase.

It is to be noticed that the maximum rating of the V_i pin 8 is 500 V. ESD protection circuitry is not currently added to this pin due to size limitations and technology constraints. Protection is limited by the drain-substrate junction in avalanche breakdown. To help increase the application safety against high voltage spike on that pin it is possible to insert a small wattage 1.0 k Ω series resistor between the V_{in} rail and pin 8.

The Figure 7 shows the V_{CC} voltage evolution in case of no external current source providing current into the V_{CC} pin during the switching phase. This case can be encountered in SMPS when the self supply through an auxiliary winding is not present (strong overload on the SMPS output for example). The Figure 17 also depicts this working configuration.

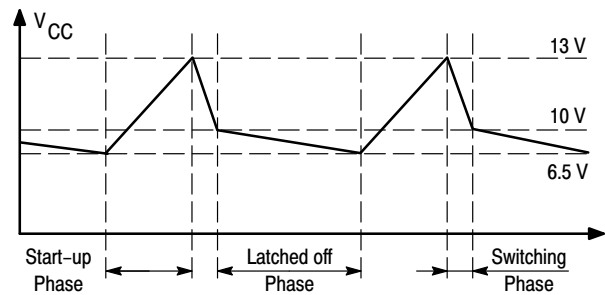


Figure 7. Hiccup Mode

In case of the hiccup mode, the duty cycle of the switching phase is in the range of 10%.

Mode Transition

The LW latch Figure 8 is the memory of the working status at the end of every switching sequence.

Two different cases must be considered for the logic at the termination of the SWITCHING PHASE:

1. No Over Current was observed
2. An Over Current was observed

These 2 cases are corresponding to the signal labelled NOC in case of “No Over Current” and “OC” in case of Over Current. So the effective working status at the end of the ON time memorized in LW corresponds to $Q=1$ for no over current and $Q=0$ for over current.

This sequence is repeated during the Switching phase.

Several events can occur:

1. SMPS switch OFF
2. SMPS output overload
3. Transition from Normal to Pulsed Mode
4. Transition from Pulsed Mode to Normal Mode

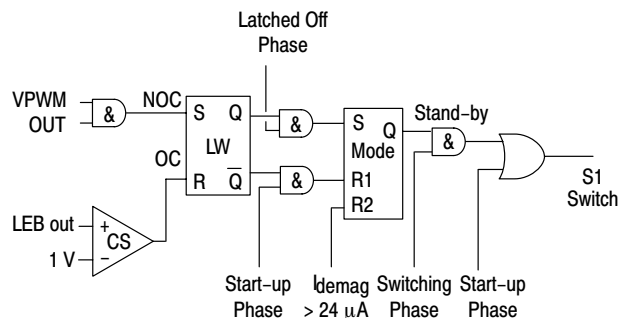


Figure 8. Transition Logic

• 1. SMPS SWITCH OFF

When the mains is switched OFF, so long as the bulk electrolytic bulk capacitor provides energy to the SMPS, the controller remains in the switching phase. Then the peak current reaches its maximum peak value, the switching frequency decreases and all the secondary voltages are reduced. The V_{CC} voltage is also reduced. When V_{CC} is equal to 10 V, the SMPS stops working.

• 2. Overload

In the hiccup mode the 3 distinct phases are described as follows (refer to Figure 7):

The SWITCHING PHASE: The SMPS output is low and the regulation block reacts by increasing the ON time ($d_{max} = 80\%$). The OC is reached at the end of every switching cycle. The LW latch (Figure 8) is reset before the VPWM signal appears. The SMPS output voltage is low. The V_{CC} voltage cannot be maintained at a normal level as the auxiliary winding provides a voltage which is also reduced in a ratio similar to the one on the output (i.e. V_{out} nominal / V_{out} short-circuit). Consequently the V_{CC} voltage is reduced at an operating rate given by the combination V_{CC} capacitor value together with the I_{CC} working consumption (3.2 mA) according to the equation 2. When V_{CC} crosses 10V the WORKING PHASE gets terminated. The LW latch remains in the reset status.

The LATCHED-OFF PHASE: The V_{CC} capacitor voltage continues to drop. When it reaches 6.5 V this phase is terminated. Its duration is governed by equation 3.

The START-UP PHASE is reinitiated. The high voltage start-up current source ($-I_{CC1} = 9.0$ mA) is activated and the MODE latch is reset. The V_{CC} voltage ramps up according to the equation 1. When it reaches 13 V, the IC enters into the SWITCHING PHASE.

The NEXT SWITCHING PHASE: The high voltage current source is inhibited, the MODE latch ($Q=0$) activates the NORMAL mode of operation. Figure 3 shows that no current is injected out pin 2. The over current sense level corresponds to 1.0 V.

As long as the overload is present, this sequence repeats. The SWITCHING PHASE duty cycle is in the range of 10%.

• 3. Transition from Normal to Pulsed Mode

In this sequence the secondary side is reconfigured (refer to the typical application schematic on page 13). The high voltage output value becomes lower than the NORMAL mode regulated value. The TL431 shunt regulator is fully OFF. In the SMPS stand-by mode all the SMPS outputs are lowered except for the low voltage output that supply the wake-up circuit located at the isolated side of the power supply. In that mode the secondary regulation is performed by the zener diode connected in parallel to the TL431.

The secondary reconfiguration status can be detected on the SMPS primary side by measuring the voltage level present on the auxiliary winding $Laux$. (Refer to the Demagnetization Section). In the reconfigured status, the $Laux$ voltage is also reduced. The V_{CC} self-powering is no longer possible thus the SMPS enters in a hiccup mode similar to the one described under the Overload condition.

In the SMPS stand-by mode the 3 distinct phases are:

The SWITCHING PHASE: Similar to the Overload mode. The current sense clamping level is reduced

according to the equation of the current sense section, page 5. The C.S. clamping level depends on the power to be delivered to the load during the SMPS stand-by mode. Every switching sequence ON/OFF is terminated by an OC as long as the secondary Zener diode voltage has not been reached. When the Zener voltage is reached the ON cycle is terminated by a true PWM action. The proper SWITCHING PHASE termination must correspond to a NOC condition. The LW latch stores this NOC status.

The LATCHED OFF PHASE: The MODE latch is set.

The START-UP PHASE is similar to the Overload Mode. The MODE latch remains in its set status ($Q=1$).

The SWITCHING PHASE: The Stand-by signal is validated and the 200 μ A is sourced out of the Current Sense pin 2.

• 4. Transition from Stand-by to Normal

The secondary reconfiguration is removed. The regulation on the low voltage secondary rail can no longer be achieved, thus at the end of the SWITCHING PHASE, no PWM condition can be encountered. The LW latch is reset.

At the next WORKING PHASE a NORMAL mode status takes place.

In order to become independent of the recovery time constant on the secondary side of the SMPS an additional reset input R2 is provided on the MODE latch. The condition $I_{demag} < 24 \mu A$ corresponds to the activation of the secondary reconfiguration status. The R2 reset insures a direct return into the Normal Mode.

Pulsed Mode Duty Cycle Control

During the sleep mode of the SMPS the switch S3 is closed and the control input pin 3 is connected to a 4.6 V voltage source thru a 500 Ω resistor. The discharge rate of the V_{CC} capacitor is given by $I_{CC-latch}$ (device consumption during the LATCHED OFF phase) in addition to the current drawn out of the pin 3. Connecting a resistor between the Pin 3 and GND ($R_{DPULSED}$) a programmable current is drawn from the V_{CC} through pin 3. The duration of the LATCHED OFF phase is impacted by the presence of the resistor $R_{DPULSED}$. The equation 3 shows the relation to the pin 3 current.

Pulsed Mode Phases

Equations 1 through 8 define and predict the effective behavior during the PULSED MODE operation. The equations 6, 7, and 8 contain K, Y, and D factors. These factors are combinations of measured parameters. They appear in the parameter section “Kfactors for pulsed mode operation” page 4. In equations 3 through 8 the pin 3 current is the current defined in the above section “Pulsed Mode Duty Cycle Control”.

EQUATION 1

Start-up Phase Duration:

$$t_{\text{start-up}} = \frac{C_{V_{CC}} \times (V_{\text{stup}} - UVLO2)}{I_{\text{stup}}}$$

where: I_{stup} is the start-up current flowing through V_{CC} pin
 $C_{V_{CC}}$ is the V_{CC} capacitor value

EQUATION 2

Switching Phase Duration:

$$t_{\text{switch}} = \frac{C_{V_{CC}} \times (V_{\text{stup}} - UVLO1)}{I_{\text{ccS}} + I_G}$$

where: I_{ccS} is the no load circuit consumption in switching phase
 I_G is the current consumed by the Power Switch

EQUATION 3

Latched-off Phase Duration:

$$t_{\text{latched-off}} = \frac{C_{V_{CC}} \times (UVLO1 - UVLO2)}{I_{\text{ccL}} + I_{\text{pin3}}}$$

where: I_{ccL} is the latched off phase consumption
 I_{pin3} is the current drawn from pin3 adding a resistor

EQUATION 4

Burst Mode Duty Cycle:

$$d_{\text{BM}} = \frac{t_{\text{switch}}}{t_{\text{start-up}} + t_{\text{switch}} + t_{\text{latched-off}}}$$

EQUATION 5

$$d_{\text{BM}} = \frac{\frac{C_{V_{CC}} \times (V_{\text{stup}} - UVLO1)}{I_{\text{ccS}} + I_G}}{\frac{C_{V_{CC}} \times (V_{\text{stup}} - UVLO2)}{I_{\text{stup}}} + \frac{C_{V_{CC}} \times (V_{\text{stup}} - UVLO1)}{I_{\text{ccS}} + I_G} + \frac{C_{V_{CC}} \times (UVLO1 - UVLO2)}{I_{\text{ccL}} + I_{\text{pin3}}}}$$

EQUATION 6

$$d_{\text{BM}} = \frac{1}{1 + \left(k_{S/\text{Stup}} \times \frac{I_{\text{ccS}} + I_G}{I_{\text{stup}}} \right) + \left(k_{S/L} \times \frac{I_{\text{ccS}} + I_G}{I_{\text{ccL}} + I_{\text{pin3}}} \right)}$$

where: $k_{S/\text{Stup}} = (V_{\text{stup}} - UVLO2)/(V_{\text{stup}} - UVLO1)$
 $k_{S/L} = (UVLO1 - UVLO2)/(V_{\text{stup}} - UVLO1)$

EQUATION 7

$$d_{BM} = \frac{1}{1 + \left[\frac{I_{ccS} + I_G}{I_{stup}} \times \left(k_{S/Stup} + \left(k_{S/L} \times \frac{I_{stup}}{I_{ccL} + I_{pin3}} \right) \right) \right]}$$

EQUATION 8

$$d_{BM} = \frac{1}{1 + \left\{ \left(k1 + \frac{I_G}{I_{stup}} \right) \times \left[k_{S/Stup} + \left(k_{S/L} \times \frac{1}{k2 + \left(\frac{I_{pin3}}{I_{stup}} \right)} \right) \right] \right\}}$$

where: $k1 = I_{ccS}/I_{stup}$

$k2 = I_{ccL}/I_{stup}$

$k_{S/Stup} = (V_{stup} - UVLO2)/(V_{stup} - UVLO1)$

$k_{S/L} = (UVLO1 - UVLO2)/(V_{stup} - UVLO1)$

PULSED MODE CURRENT SENSE CLAMPING LEVEL

Equations 9, 10, 11 and 12 allow the calculation of the R_{cs} value for the desired maximum current peak value during the SMPS stand-by mode.

EQUATION 9

$$I_{pk_stby} = \frac{V_{cs-th} - (R_{cs} \times I_{cs})}{R_S}$$

where: V_{cs-th} is the CS comparator threshold

I_{cs} is the CS internal current source

R_S is the sensing resistor

R_{cs} is the resistor connected between pin 2 and R_S

EQUATION 10

$$I_{pk_stby} = V_{cs-th} \times \frac{1 - \left(R_{cs} \times \frac{I_{cs}}{V_{cs-th}} \right)}{R_S}$$

EQUATION 11

$$I_{pk_stby} = V_{cs-th} \times \frac{1 - (R_{cs} \times Y_{cs-stby})}{R_S}$$

where: $Y_{cs-stby} = I_{cs}/V_{cs-th}$

Taking into account the circuit propagation delay (δt_{cs}) and the Power Switch reaction time (δt_{ps}):

EQUATION 12

$$I_{pk_stby} = \left[V_{cs-th} \times \frac{1 - (R_{cs} \times Y_{cs-stby})}{R_S} \right] + \frac{V_{in} \times (\delta t_{cs} + \delta t_{ps})}{L_p}$$

MC44608

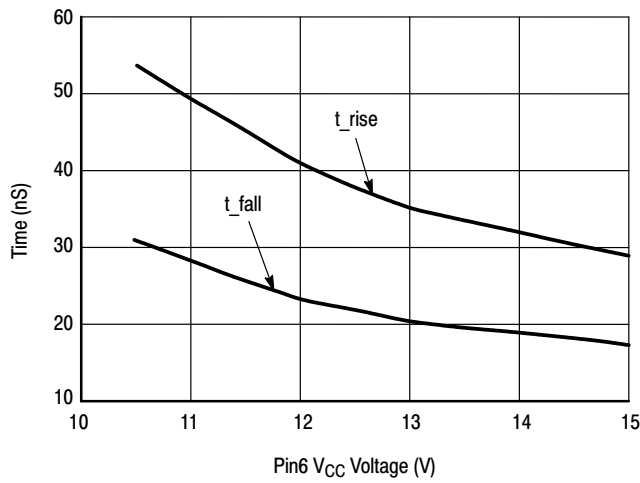


Figure 9. Output Switching Speed

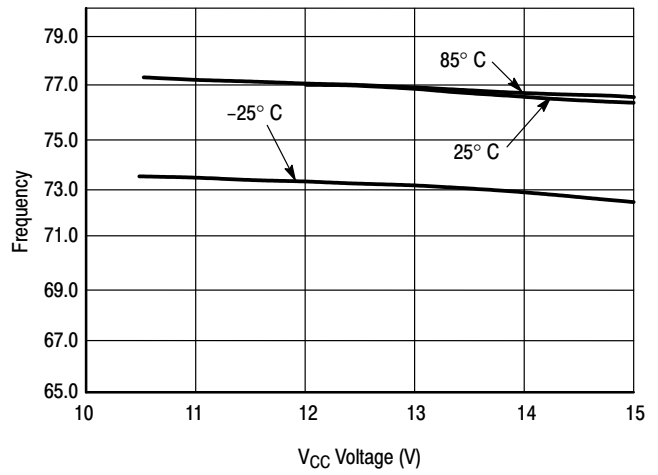


Figure 10. Frequency Stability

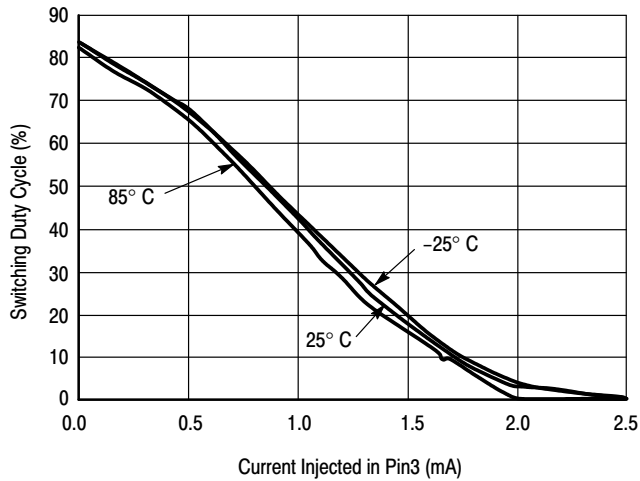


Figure 11. Duty Cycle Control

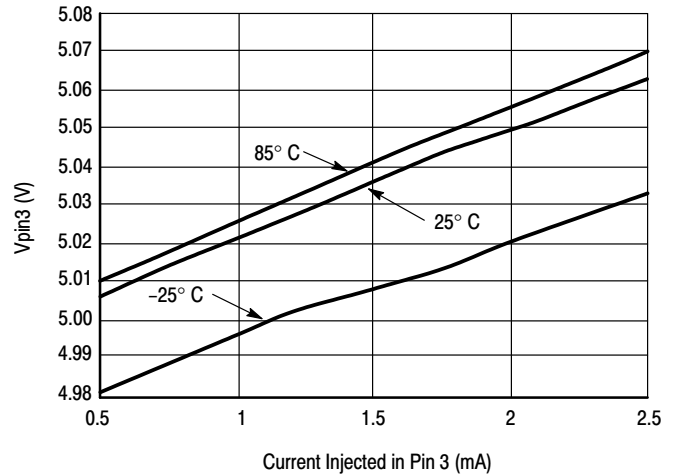


Figure 12. Vpin3 During the Working Period

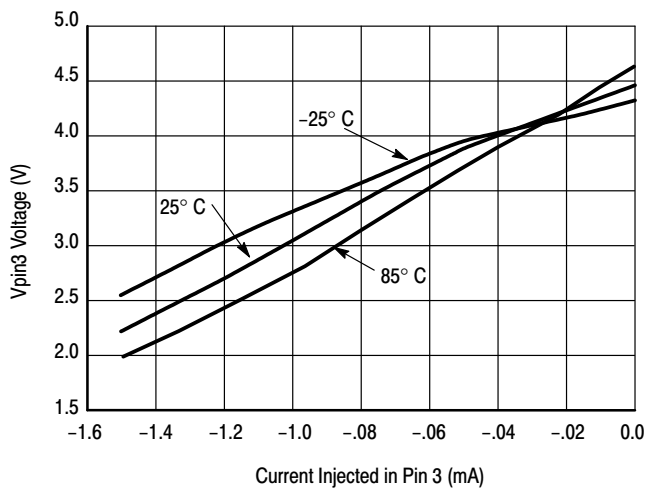


Figure 13. Vpin3 During the Latched Off Period

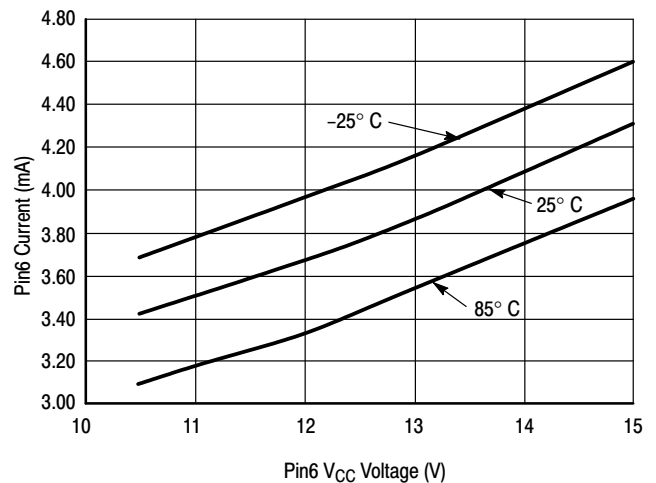


Figure 14. Device Consumption when Switching

MC44608

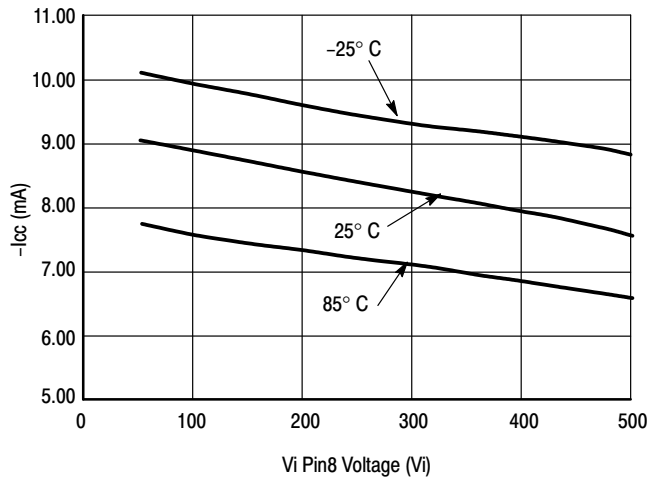


Figure 15. High Voltage Current Source

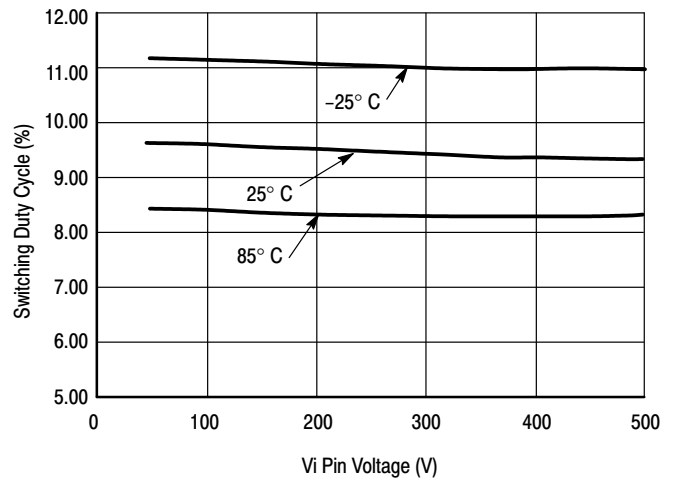


Figure 16. Overload Burst Mode

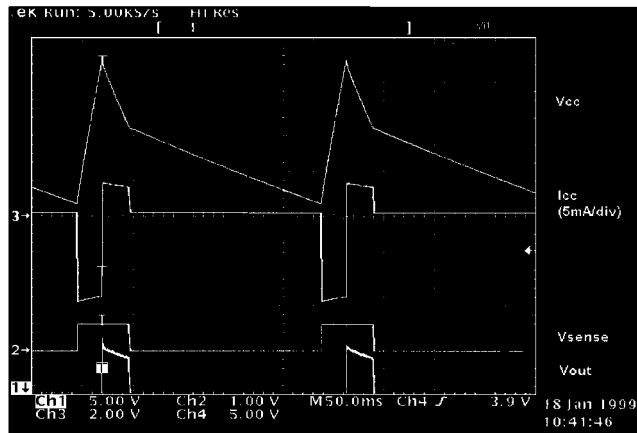


Figure 17. Hiccup Mode Waveforms

The data in Figure 16 corresponds to the waveform in Figure 17. The Figure 17 shows V_{CC} , I_{CC} , I_{sense} (pin 2) and V_{out} (pin 5). V_{out} (pin 5) in fact shows the envelope of the

output switching pulses. This mode corresponds to an overload condition.

MC44608

The Figure 19 represents a complete power supply using the secondary reconfiguration.

The specification is as follows:

Input source:	85 Vac to 265 Vac
3 Outputs	112 V/0.45 A
	16 V/1.5 A
	8.0 V/1.0 A
Output power	80 W
Stand-by mode	@ Pout = 300 mW, 1.3 W

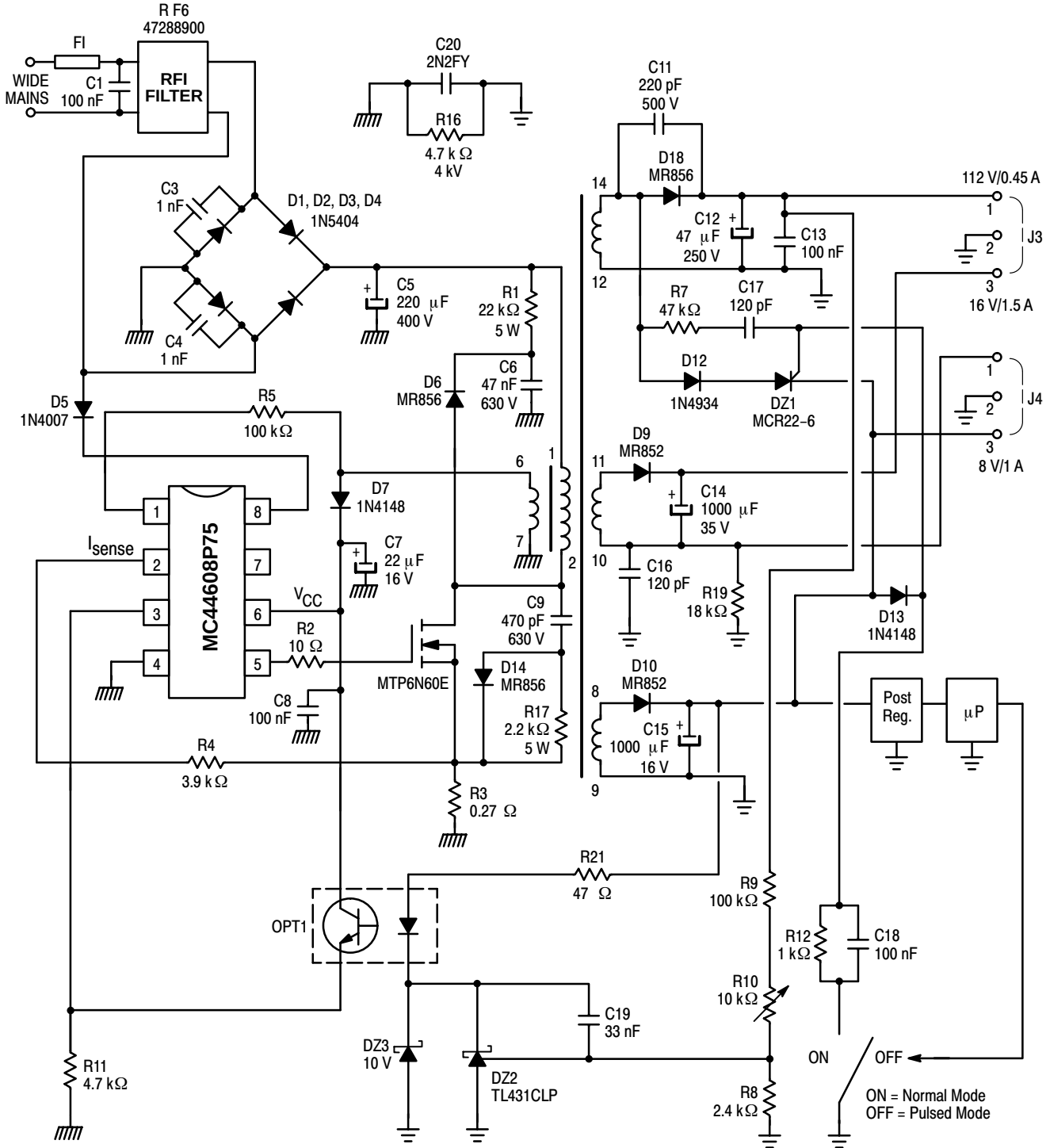


Figure 18. Typical Application

The secondary reconfiguration is activated by the μP through the switch. The dV/dt appearing on the high voltage winding (pins 14 of the transformer) at every TMOS switch off, produces a current spike through the series RC network R7, C17. According to the switch position this spike is either absorbed by the ground (switch closed) or flows into the thyristor gate (switch open) thus firing the MCR22-6. The closed position of the switch corresponds to the Pulsed Mode activation. In this secondary side SMPS status the high voltage winding (12-14) is connected through D12 and DZ1 to the 8.0 V low voltage secondary rail. The voltages

applied to the secondary windings 12-14, 10-11 and 6-7 (Vaux) are thus divided by ratio N_{12-14} / N_{9-8} (number of turns of the winding 12-14 over number of turns of the winding 9-8). In this reconfigured status all the secondary voltages are lowered except the 8.0 V one. The regulation during every pulsed or burst is performed by the zener diode DZ3 which value has to be chosen higher than the normal mode regulation level. This working mode creates a voltage ripple on the 8.0 V rail which generally must be post regulated for the microProcessor supply.

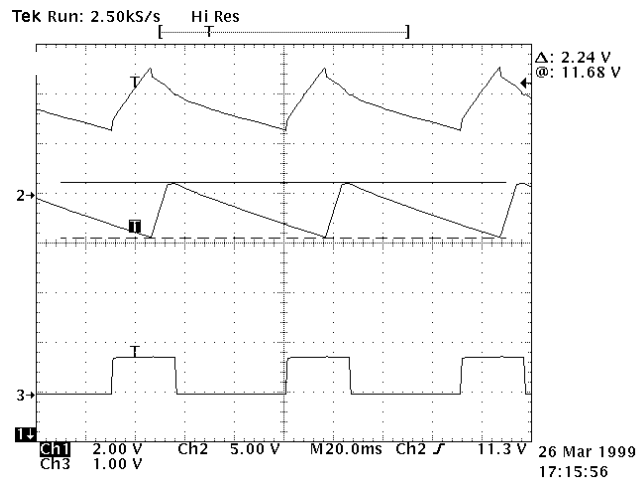


Figure 19. SMPS Pulsed Mode

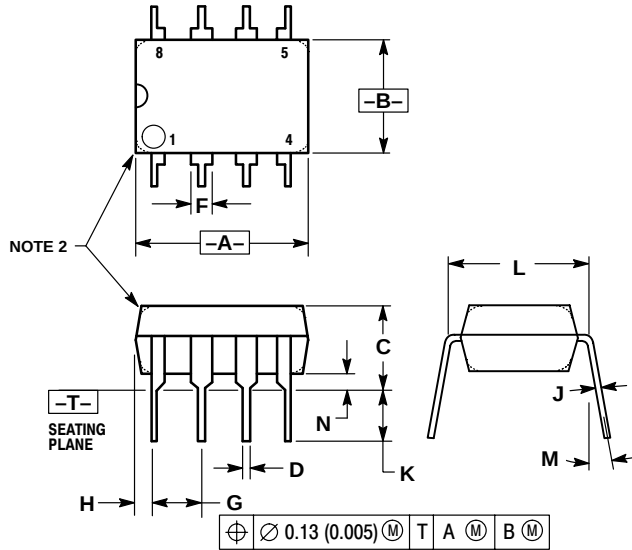
The Figure 19 shows the SMPS behavior while working in the reconfigured mode. The top curve represents the V_{CC} voltage (pin 6 of the MC44608). The middle curve represents the 8.0 V rail. The regulation is taking place at 11.68 V. On the bottom curve the pin 2 voltage is shown. This voltage represents the current sense signal. The pin 2

voltage is the result of the $200 \mu A$ current source activated during the start-up phase and also during the working phase which flows through the R4 resistor. The used high resolution mode of the oscilloscope does not allow to show the effective t_{on} current flowing in the sensing resistor R11.

MC44608

PACKAGE DIMENSIONS

PDIP-8
P SUFFIX
PLASTIC PACKAGE
CASE 626-05
ISSUE K



NOTES:

1. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
2. PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS).
3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.40	10.16	0.370	0.400
B	6.10	6.60	0.240	0.260
C	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	---	10°	---	10°
N	0.76	1.01	0.030	0.040

STYLE 1:

- PIN 1: AC IN
2. DC + IN
3. DC - IN
4. AC IN
5. GROUND
6. OUTPUT
7. AUXILIARY
8. V_{CC}

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

NORTH AMERICA Literature Fulfillment:

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: ONlit@hibbertco.com
Fax Response Line: 303-675-2167 or 800-344-3810 Toll Free USA/Canada

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

EUROPE: LDC for ON Semiconductor – European Support

German Phone: (+1) 303-308-7140 (Mon-Fri 2:30pm to 7:00pm CET)
Email: ONlit-german@hibbertco.com

French Phone: (+1) 303-308-7141 (Mon-Fri 2:00pm to 7:00pm CET)
Email: ONlit-french@hibbertco.com

English Phone: (+1) 303-308-7142 (Mon-Fri 12:00pm to 5:00pm GMT)
Email: ONlit@hibbertco.com

EUROPEAN TOLL-FREE ACCESS*: 00-800-4422-3781

*Available from Germany, France, Italy, UK, Ireland

CENTRAL/SOUTH AMERICA:

Spanish Phone: 303-308-7143 (Mon-Fri 8:00am to 5:00pm MST)

Email: ONlit-spanish@hibbertco.com

Toll-Free from Mexico: Dial 01-800-288-2872 for Access –
then Dial 866-297-9322

ASIA/PACIFIC: LDC for ON Semiconductor – Asia Support

Phone: 303-675-2121 (Tue-Fri 9:00am to 1:00pm, Hong Kong Time)

Toll Free from Hong Kong & Singapore:

001-800-4422-3781

Email: ONlit-asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center

4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-0031

Phone: 81-3-5740-2700

Email: r14525@onsemi.com

ON Semiconductor Website: <http://onsemi.com>

For additional information, please contact your local
Sales Representative.